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1. Name of conveying party(ies): **4-14-04** **08-11-2004**  
 Tsuyoshi KOBAYASHI  
 Shigetsugu MURAMATSU  
 Takuya KAZAMA



2. Name and Address of receiving party(ies): **102812020**  
  
 SHINKO ELECTRIC INDUSTRIES CO., LTD.  
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 Nagano-shi 381-2287  
 JAPAN

3. Nature of conveyance:  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Other: \_\_\_\_\_  
 Execution Date(s): April 2, 2004

4. Application number(s) or patent number(s):  
 This document is being filed together with a new application:  
 (a) The execution date(s) of the application is/are: April 2, 2004  
 (b) The title is: SEMICONDUCTOR COMPONENT  
 OR  
 This document is being filed after filing of the application:  
 (a) Patent Application No(s) , filed April 14, 2004; or  
 (b) Patent No(s) , issued .

5. Name and address of party to whom correspondence concerning document should be mailed:  
 STAAS & HALSEY LLP Our Docket: 300.1157  
 Attention: H. J. Staas  
 1201 New York Ave., N.W., Suite 700  
 Washington, D.C. 20005

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)  
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8. Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Deposit Account)  
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H. J. Staas, Reg. No. 22,010  
 Name of Person Signing

*H. J. Staas*  
 Signature

April 14, 2004  
 Date

Total number of pages including cover sheet: 2

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# U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert  
ASSIGNEE's  
Name(s)  
Address(es))

SHINKO ELECTRIC INDUSTRIES CO., LTD.

80, Oshimada-machi, Nagano-shi, Nagano 381-2287, Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of  
Invention)

SEMICONDUCTOR COMPONENT

relating to International Patent Application PCT/JP 02 / 10611 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date  
of execution  
of application,  
if not  
concurrent)

(a) executed on \_\_\_\_\_ ;  
(b) filed on \_\_\_\_\_ ;  
Serial No. \_\_\_\_\_ / \_\_\_\_\_ ;

( _____ ) is hereby authorized to insert in (b) the specified data, when known.
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and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

1) <u>Tsuyoshi Kobayashi</u> (SIGNATURE)	Tsuyoshi Kobayashi (TYPE NAME)	April 2, 2004 (DATE)
2) <u>Shigetsugu Muramatsu</u> (SIGNATURE)	Shigetsugu Muramatsu (TYPE NAME)	April 2, 2004 (DATE)
3) <u>Takuya Kazama</u> (SIGNATURE)	Takuya Kazama (TYPE NAME)	April 2, 2004 (DATE)
4) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
5) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
6) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
7) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
8) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)